

NTK3134N

MOSFET – Power, Single, N-Channel with ESD Protection, SOT-723

20 V, 890 mA



ON Semiconductor®

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Features

- N-Channel Switch with Low $R_{DS(on)}$
- 44% Smaller Footprint and 38% Thinner than SC89
- Low Threshold Levels Allowing 1.5 V $R_{DS(on)}$ Rating
- Operated at Low Logic Level Gate Drive
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Load/Power Switching
- Interface Switching
- Logic Level Shift
- Battery Management for Ultra Small Portable Electronics

MAXIMUM RATINGS ($T_J = 25^\circ\text{C}$ unless otherwise stated)

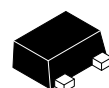
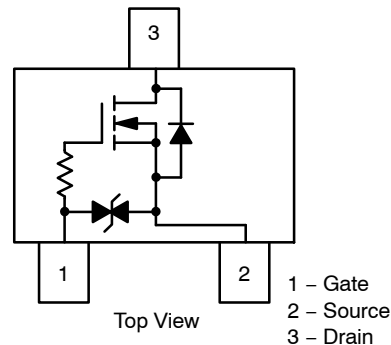
Parameter		Symbol	Value	Unit	
Drain-to-Source Voltage		V_{DSS}	20	V	
Gate-to-Source Voltage		V_{GS}	± 8	V	
Continuous Drain Current (Note 1)	Steady State	$T_A = 25^\circ\text{C}$	I_D	890	mA
		$T_A = 85^\circ\text{C}$		640	
	$t \leq 5\text{ s}$	$T_A = 25^\circ\text{C}$		990	
Power Dissipation (Note 1)	Steady State	$T_A = 25^\circ\text{C}$	P_D	450	mW
	$t \leq 5\text{ s}$			550	
Continuous Drain Current (Note 2)	Steady State	$T_A = 25^\circ\text{C}$	I_D	750	mA
		$T_A = 85^\circ\text{C}$		540	
Power Dissipation (Note 2)		$T_A = 25^\circ\text{C}$	P_D	310	mW
Pulsed Drain Current	$t_p = 10\ \mu\text{s}$	I_{DM}	1.8	A	
Operating Junction and Storage Temperature		T_J, T_{STG}	-55 to 150	$^\circ\text{C}$	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		T_L	260	$^\circ\text{C}$	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Surface mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces)
2. Surface mounted on FR4 board using the minimum recommended pad size

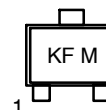
$V_{(BR)DSS}$	$R_{DS(on)}$ TYP	I_D Max
20 V	0.20 Ω @ 4.5 V	890 mA
	0.26 Ω @ 2.5 V	790 mA
	0.43 Ω @ 1.8 V	700 mA
	0.56 Ω @ 1.5 V	200 mA

SOT-723 (3-LEAD)



SOT-723
CASE 631AA
STYLE 5

MARKING DIAGRAM



KF = Specific Device Code
M = Date Code

ORDERING INFORMATION

Device	Package	Shipping†
NTK3134NT1G	SOT-723	4000 / Tape & Reel
NTK3134NT5G	SOT-723	8000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Ambient – Steady State (Note 3)	$R_{\theta JA}$	280	°C/W
Junction-to-Ambient – $t = 5$ s (Note 3)	$R_{\theta JA}$	228	
Junction-to-Ambient – Steady State Minimum Pad (Note 4)	$R_{\theta JA}$	400	

3. Surface mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces)
 4. Surface mounted on FR4 board using the minimum recommended pad size

MOSFET ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0$ V, $I_D = 250$ μA	20			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	$V_{(BR)DSS}/T_J$	$I_D = 250$ μA , Reference to 25°C		18		mV/°C
Zero Gate Voltage Drain Current	I_{DSS}	$V_{GS} = 0$ V, $V_{DS} = 16$ V	$T_J = 25^\circ\text{C}$		1.0	μA
			$T_J = 125^\circ\text{C}$		2.0	
Gate-to-Source Leakage Current	I_{GSS}	$V_{DS} = 0$ V, $V_{GS} = \pm 4.5$ V			± 0.5	μA

ON CHARACTERISTICS (Note 5)

Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS} = V_{DS}$, $I_D = 250$ μA	0.45		1.2	V
Negative Threshold Temperature Coefficient	$V_{GS(TH)}/T_J$			2.4		mV/°C
Drain-to-Source On Resistance	$R_{DS(on)}$	$V_{GS} = 4.5$ V, $I_D = 890$ mA		0.20	0.35	Ω
		$V_{GS} = 2.5$ V, $I_D = 780$ mA		0.26	0.45	
		$V_{GS} = 1.8$ V, $I_D = 700$ mA		0.43	0.65	
		$V_{GS} = 1.5$ V, $I_D = 200$ mA		0.56	1.2	
Forward Transconductance	g_{FS}	$V_{DS} = 10$ V, $I_D = 800$ mA		1.6		S

CHARGES, CAPACITANCES AND GATE RESISTANCE

Input Capacitance	C_{ISS}	$V_{GS} = 0$ V, $f = 1$ MHz, $V_{DS} = 16$ V		79	120	pF
Output Capacitance	C_{OSS}			13	20	
Reverse Transfer Capacitance	C_{RSS}			9.0	15	

SWITCHING CHARACTERISTICS, $V_{GS} = 4.5$ V (Note 6)

Turn On Delay Time	$t_{d(ON)}$	$V_{GS} = 4.5$ V, $V_{DS} = 10$ V, $I_D = 500$ mA, $R_G = 10$ Ω		6.7		ns
Rise Time	t_r			4.8		
TurnOff Delay Time	$t_{d(OFF)}$			17.3		
Fall Time	t_f			7.4		

DRAIN SOURCE DIODE CHARACTERISTICS

Forward Diode Voltage	V_{SD}	$V_{GS} = 0$ V, $I_S = 350$ mA	$T_J = 25^\circ\text{C}$		0.75	1.2	V
Reverse Recovery Time	t_{RR}	$V_{GS} = 0$ V, $dI_{SD}/dt = 100$ A/ μs , $I_S = 1.0$ A, $V_{DD} = 20$ V			8.1		ns
Charge Time	t_a				6.4		
Discharge Time	t_b				1.7		
Reverse Recovery Charge	Q_{RR}				3.0		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

5. Pulse Test: pulse width = 300 μs , duty cycle = 2%
 6. Switching characteristics are independent of operating junction temperatures

TYPICAL CHARACTERISTICS

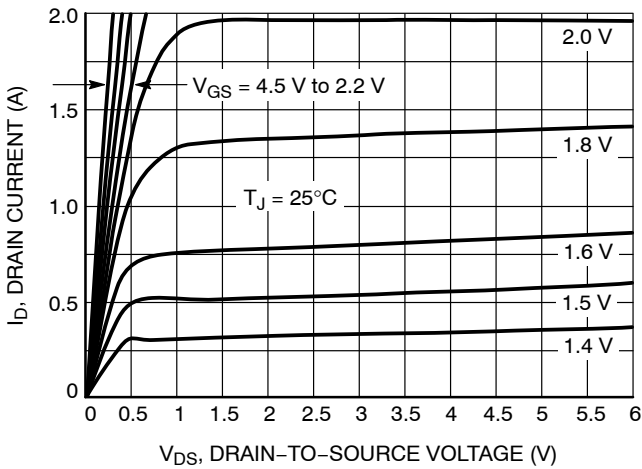


Figure 1. On-Region Characteristics

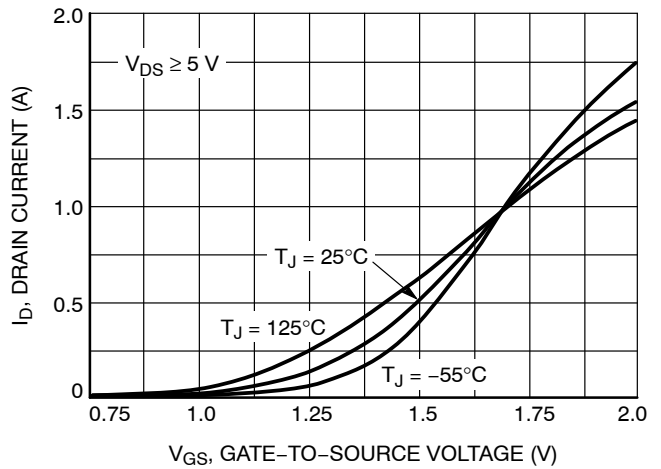


Figure 2. Transfer Characteristics

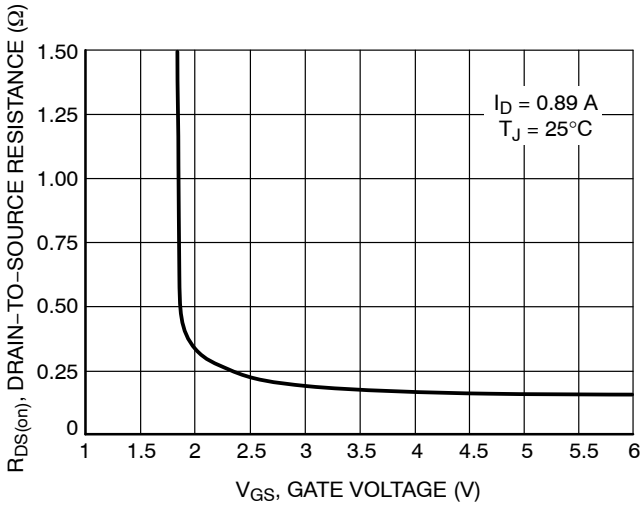


Figure 3. On-Resistance vs. Gate-to-Source Voltage

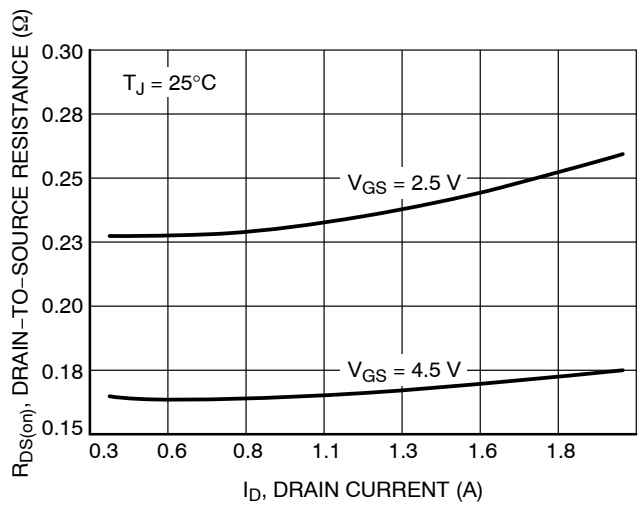


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

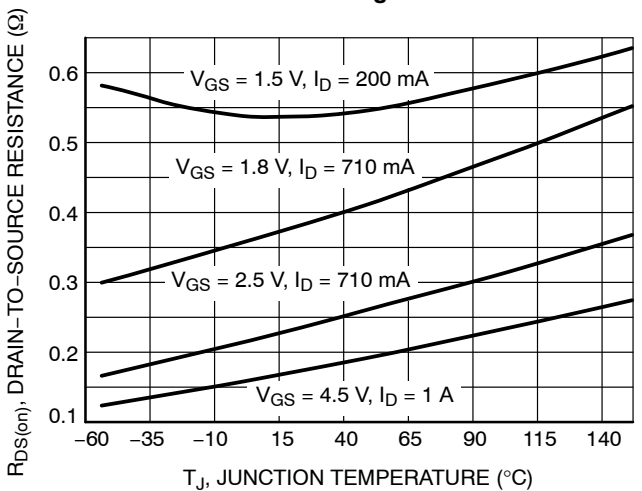


Figure 5. On-Resistance Variation with Temperature

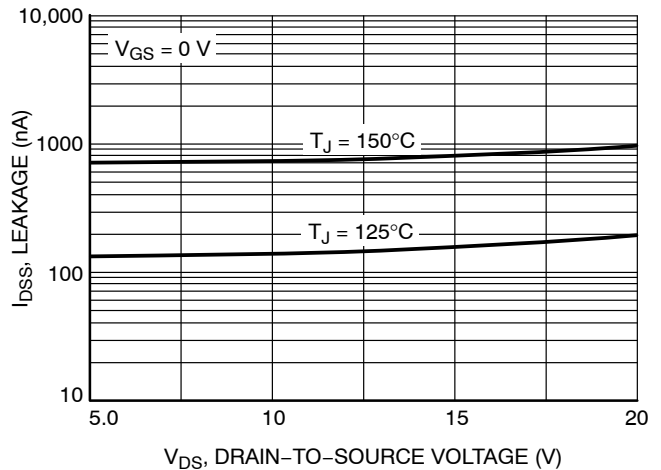


Figure 6. Drain-to-Source Leakage Current vs. Voltage

NTK3134N

TYPICAL CHARACTERISTICS

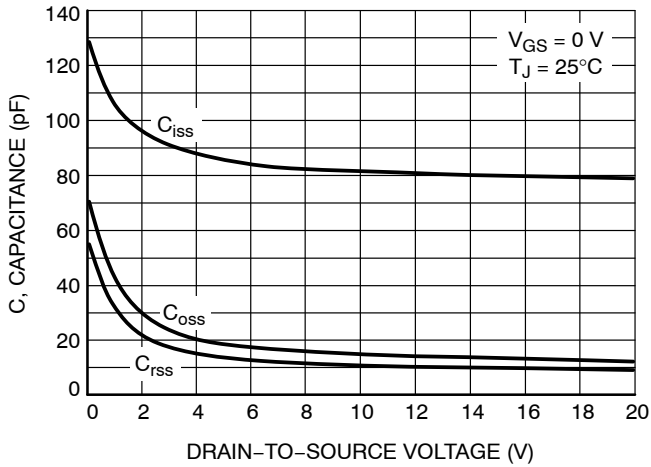


Figure 7. Capacitance Variation

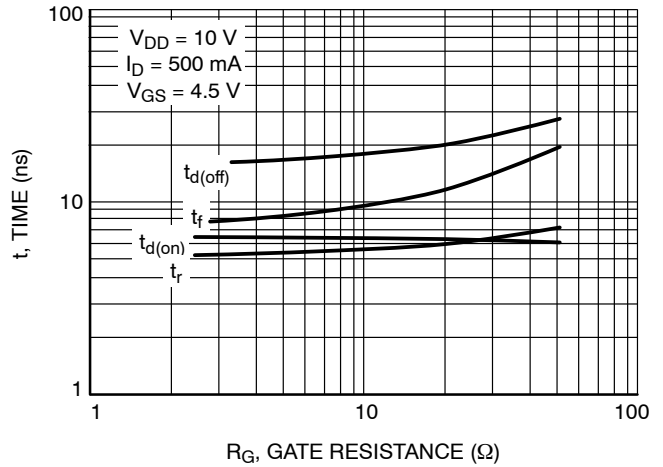


Figure 8. Resistive Switching Time Variation vs. Gate Resistance

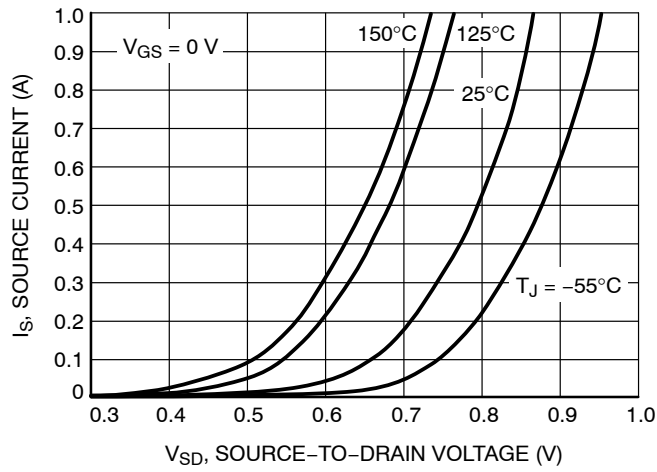


Figure 9. Diode Forward Voltage vs. Current

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

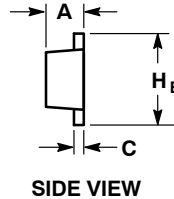
ON Semiconductor®



SCALE 4:1

SOT-723
CASE 631AA-01
ISSUE D

DATE 10 AUG 2009

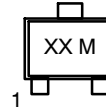


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

MILLIMETERS			
DIM	MIN	NOM	MAX
A	0.45	0.50	0.55
b	0.15	0.21	0.27
b1	0.25	0.31	0.37
C	0.07	0.12	0.17
D	1.15	1.20	1.25
E	0.75	0.80	0.85
e	0.40 BSC		
H E	1.15	1.20	1.25
L	0.29 REF		
L2	0.15	0.20	0.25

GENERIC MARKING DIAGRAM*



XX = Specific Device Code
M = Date Code

- | | | | | |
|---|--|--|--|--|
| STYLE 1:
PIN 1. BASE
2. EMITTER
3. COLLECTOR | STYLE 2:
PIN 1. ANODE
2. N/C
3. CATHODE | STYLE 3:
PIN 1. ANODE
2. ANODE
3. CATHODE | STYLE 4:
PIN 1. CATHODE
2. CATHODE
3. ANODE | STYLE 5:
PIN 1. GATE
2. SOURCE
3. DRAIN |
|---|--|--|--|--|

RECOMMENDED SOLDERING FOOTPRINT*



*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G", may or not be present.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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